

Available Q2, 1995

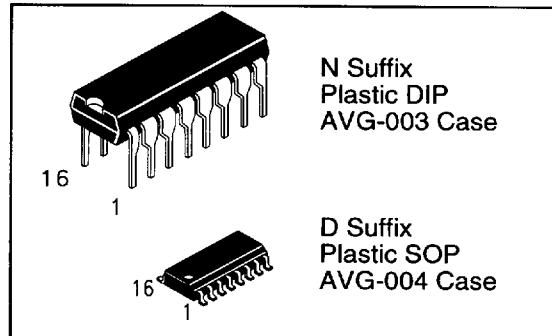
### 4-Bit Full Adder

These devices are high-speed 4-bit binary Full Adders with internal carry look-a-head. The device adds two 4-bit words (A and B) plus the Carry-In bit. The binary sum appears at the Sum outputs (S), and any resulting carries appear at the Carry-Out pin.

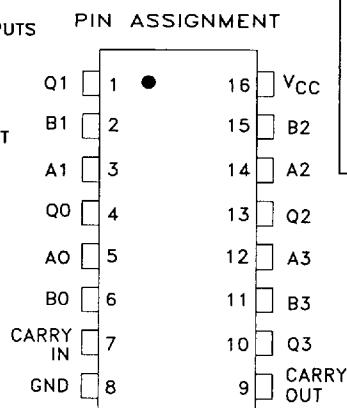
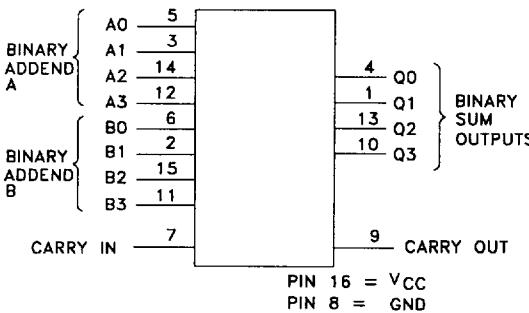
The '283 can be used either with all inputs and outputs active-high (positive logic) or active-low (negative logic). With active-high inputs, Carry In must be held low when no carry-in is intended.

- Output Drive Capability: 10 LSTTL Loads**
- Outputs Directly Interface to CMOS, NMOS, and TTL**
- Operating Voltage Range: 2 to 6 V for HC Devices**
- Low Input Current: 1  $\mu$ A**
- DC, AC parameters guaranteed from -55°C to 125°C**

**DV74HC283  
DV74HCT283**



TRUTH TABLE



Inputs			Outputs	
An	Bn	CIn=CO <sub>n-1</sub>	Qn	CO <sub>n</sub> =Cl <sub>n+1</sub>
L	L	L	L	L
L	L	H	H	L
L	H	L	H	L
L	H	H	L	H
H	L	L	H	L
H	H	H	L	H
H	H	H	H	H

n=0, 1, 2, 3 (A3, B3, and Q3 are the most significant bits)

H = High Logic Level

L = Low Logic Level

### ABSOLUTE MAXIMUM RATINGS

Maximum ratings are those values beyond which damage to the device may occur.

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	DC Supply Voltage (Referenced to GND)	-0.5 to +7.0	V
V <sub>IN</sub>	DC Input Voltage (Referenced to GND)	-1.5 to V <sub>CC</sub> +1.5	V
V <sub>OUT</sub>	DC Output Voltage (Referenced to GND)	-0.5 to V <sub>CC</sub> +0.5	V
I <sub>IN</sub>	DC Input Current, per Pin	$\pm 20$	mA
I <sub>OUT</sub>	DC Output Current, per Pin	$\pm 25$	mA
I <sub>CC</sub>	DC Supply Current, V <sub>CC</sub> and GND Pins	$\pm 50$	mA
P <sub>D</sub>	Power Dissipation in Still Air, Plastic DIP SOP Package	750 500	mW
T <sub>TSG</sub>	Storage Temperature Range	-65 to +150	°C
T <sub>L</sub>	Lead Temperature, 1mm from Case for 10 Seconds)	260	°C

## GUARANTEED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V <sub>CC</sub>	DC Supply Voltage HC(HCT), Referenced to GND	2.0(4.5)	6.0(5.5)	V
V <sub>IN</sub> , V <sub>OUT</sub>	DC Input Voltage, Output Voltage ,Referenced to GND	0	V <sub>CC</sub>	V
T <sub>A</sub>	Ambient Temperature	-55	+125	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Time: HC: V <sub>CC</sub> =2.0V HCT: V <sub>CC</sub> =5.5V / HC: V <sub>CC</sub> =4.5V HC: V <sub>CC</sub> =6.0V	0 0 0	1000 500 400	ns

HC- 283

## DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Conditions	V <sub>CC</sub> V	Guaranteed Limits			Unit
				25°C to -55°C	≤85°C	≤125°C	
V <sub>IH</sub>	Minimum High-Level Input Voltage	V <sub>OUT</sub> = 0.1 V,  I <sub>OUT</sub>   ≤ 20 μA or V <sub>OUT</sub> = V <sub>CC</sub> - 0.1V	2.0 4.5 6.0	1.5 3.15 4.2	1.5 3.15 4.2	1.5 3.15 4.2	V
V <sub>IL</sub>	Maximum Low- Level Input Voltage	V <sub>OUT</sub> = 0.1 V,  I <sub>OUT</sub>   ≤ 20 μA or V <sub>OUT</sub> = V <sub>CC</sub> - 0.1V	2.0 4.5 6.0	0.3 0.9 1.2	0.3 0.9 1.2	0.3 0.9 1.2	V
V <sub>OH</sub>	Minimum High-Level Output Voltage	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>  I <sub>OUT</sub>   ≤ 20 μA	2.0 4.5 6.0	1.9 4.4 5.9	1.9 4.4 5.9	1.9 4.4 5.9	V
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> ,  I <sub>OUT</sub>   ≤ 4.0mA  I <sub>OUT</sub>   ≤ 5.2mA	4.5 6.0	3.98 5.48	3.84 5.34	3.7 5.2	
V <sub>OL</sub>	Maximum Low Level Output Voltage	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>  I <sub>OUT</sub>   ≤ 20 μA	2.0 4.5 6.0	0.1 0.1 0.1	0.1 0.1 0.1	0.1 0.1 0.1	V
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> ,  I <sub>OUT</sub>   ≤ 4.0mA  I <sub>OUT</sub>   ≤ 5.2 mA	4.5 6.0	0.26 0.26	0.33 0.33	0.40 0.40	
I <sub>IN</sub>	Maximum Input Leakage Current	V <sub>IN</sub> = V <sub>CC</sub> or GND	6.0	± 0.1	± 1.0	± 1.0	μA
I <sub>CC</sub>	Maximum Quiescent Supply Current	V <sub>IN</sub> = V <sub>CC</sub> or GND, I <sub>OUT</sub> = 0 μA (Per Package)	6.0	8.0	80	160	μA

## AC ELECTRICAL CHARACTERISTICS over full operating conditions (C<sub>L</sub>=50pF, Input t<sub>f</sub>=t<sub>r</sub>=6ns)

Symbol	Parameter	V <sub>CC</sub> V	Guaranteed Limit			Unit
			25°C to -55°C	≤85°C	≤125°C	
t <sub>PLH</sub> , t <sub>PHL</sub>	Maximum Propogation Delay Time, Carry In to Sum Out	2.0 4.5 6.0	210 42 36	265 53 45	315 63 54	ns
t <sub>PLH</sub> , t <sub>PHL</sub>	Maximum Propogation Delay Time, A or B to Sum Out	2.0 4.5 6.0	270 54 46	340 68 58	405 81 69	ns
t <sub>PLH</sub> , t <sub>PHL</sub>	Maximum Propogation Delay Time, Carry In to Carry Out	2.0 4.5 6.0	195 39 33	245 49 42	295 59 50	ns
t <sub>PLH</sub> , t <sub>PHL</sub>	Maximum Propogation Delay Time, A or B to Carry Out	2.0 4.5 6.0	225 45 38	280 56 48	340 68 58	ns
t <sub>TLH</sub> , t <sub>THL</sub>	Maximum Output Transition Time Any Output	2.0 4.5 6.0	75 15 13	95 19 16	110 22 19	ns
C <sub>IN</sub>	Maximum Input Capacitance	—	10	10	10	pF

CPD	Power Dissipation Capacitance (Per Package) Used to determine the no-load dynamic power consumption, $P_D = CPD V_{CC}^2 f + I_{CC} V_{CC}$	Typical @ 25°C, V <sub>CC</sub> = 5 V				pF
		130				

## HCT- 283

### DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Conditions	V <sub>CC</sub> V	Guaranteed Limits						Unit	
				25°C to -55°C		≤ 85°C		≤ 125°C			
				Min	Max	Min	Max	Min	Max		
V <sub>IH</sub>	Minimum High-Level Input Voltage	V <sub>OUT</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V  I <sub>OUT</sub>   ≤ 20 μA	4.5 5.5	2.00 2.00		2.00 2.00		2.00 2.00		V	
V <sub>IL</sub>	Maximum Low- Level Input Voltage	V <sub>OUT</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V  I <sub>OUT</sub>   ≤ 20 μA	4.5 5.5		0.80 0.80		0.80 0.80		0.80 0.80	V	
V <sub>OH</sub>	Minimum High-Level Output Voltage	V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub>  I <sub>OUT</sub>   ≤ 20 μA	4.5 5.5	4.40 5.40		4.40 5.40		4.40 5.40		V	
		V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub>  I <sub>OUT</sub>   ≤ 4.0 mA	4.5	3.98		3.84		3.70		V	
V <sub>OL</sub>	Maximum Low Level Output Voltage	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>  I <sub>OUT</sub>   ≤ 20 μA	4.5 5.5		0.1 0.1		0.1 0.1		0.1 0.1	V	
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>  I <sub>OUT</sub>   ≤ 4.0mA	4.5	0.26		0.33		0.40		V	
I <sub>IN</sub>	Maximum Input Leakage Current	V <sub>IN</sub> = V <sub>CC</sub> or GND	5.5		± 0.1		± 1.0		± 1.0	μA	
I <sub>CC</sub>	Maximum Quiescent Supply Current	V <sub>IN</sub> = V <sub>CC</sub> or GND  I <sub>OUT</sub>   = 0 μA	5.5		8.0		80		80	μA	
Δ I <sub>CC</sub>	Additional Quiescent Supply Current	V <sub>IN</sub> =2.4V, Any One Input V <sub>IN</sub> =V <sub>CC</sub> or GND, Other Inputs  I <sub>OUT</sub>  =0 μA	5.5		≥ -55°C		25°C to 125°C			mA	
					2.9		2.4				

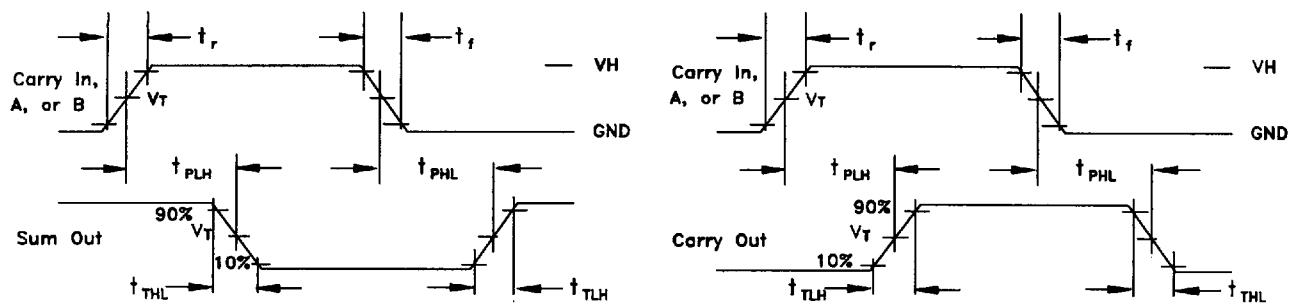
### AC ELECTRICAL CHARACTERISTICS over full operating conditions (C<sub>L</sub>=50pF, Input t<sub>f</sub>=t<sub>r</sub>=6ns)

Symbol	Parameter	V <sub>CC</sub> V	Guaranteed Limit			Unit
			25°C to -55°C	≤ 85°C	≤ 125°C	
t <sub>PLH</sub> , t <sub>PHL</sub>	Maximum Propogation Delay Time, Carry In to Sum Out	5.0 ± 10%	42	53	63	ns
	Maximum Propogation Delay Time, A or B to Sum Out		54	68	81	ns
	Maximum Propogation Delay Time, Carry In to Carry Out		39	49	59	ns
	Maximum Propogation Delay Time, A or B to Carry Out		45	56	68	ns
	Maximum Output Transition Time Any Output		15	19	22	ns
C <sub>IN</sub>	Maximum Input Capacitance	—	10	10	10	pF

CPD	Power Dissipation Capacitance (Per Package) Used to determine the no-load dynamic power consumption, $P_D = CPD V_{CC}^2 f + I_{CC} V_{CC}$	Typical @ 25°C, V <sub>CC</sub> = 5 V				pF
		130				

283

## SWITCHING WAVEFORMS



Input and output threshold voltage:  
 $V_T = 50\% V_{CC}$  for HC; 1.3V for HCT;  
 $V_H = V_{CC}$  for HC, 3V for HCT